

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Hung-Wen SU et al.

Application No.: 10/814,175

Confirmation No.: 7374

Filed: April 1, 2004

Art Unit: 1795

For: METHOD AND APPARATUS FOR
ELECTROPLATING

Examiner: H. D. Wilkins III

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated December 12, 2007, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 8 of this paper.